

April 2009

HCPL0452, HCPL0453, HCPL0500, HCPL0501, HCPL0530, HCPL0531, HCPL0534 High Speed Transistor Optocouplers

Single Channel: HCPL0452 HCPL0453 HCPL0500 HCPL0501

Dual Channel: HCPL0530 HCPL0531 HCPL0534

Features

- High speed 1 MBit/s
- 15kV/µs minimum commone mode transient immunity at V_{CM} = 1500V (HCPL0453/0534)
- Open collector output
- Guaranteed performance over temperature: 0°C to 70°C
- U.L. recognized (File # E90700)
- VDE0884 recognized (file#136616)
 - approval pending for HCPL0530/0531/0453
 - ordering option V, e.g., HCPL0500V
- BSI recognized (file# 8661, 8662)
 - HCPL0452/0500/0501 only

Applications

- Line receivers
- Pulse transformer replacement
- Output interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling

Description

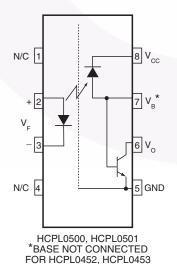
The HCPL05XX, and HCPL04XX optocouplers consist of an AlGaAs LED optically coupled to a high speed photodetector transistor housed in a compact 8-pin small outline package.

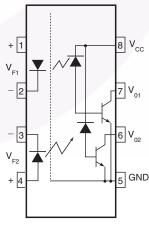
A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base-collector capacitance of the input transistor. The HCPL04XX devices do not have the base bonded out to a lead for additional noise margin. The HCPL053X devices have two channels per package for optimum mounting density.

Truth Table (positive Logic)

LED	Vo
ON	LOW
OFF	HIGH

Schematics





HCPL0530/HCPL0531/HCPL0534

Absolute Maximum Ratings ($T_A = 25^{\circ}$ C unless otherwise specified) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Units
T _{STG}	Storage Temperature	-40 to +125	°C
T _{OPR}	Operating Temperature	-40 to +85	°C
	Reflow Temperature Profile (Refer to page 11)		
EMITTER			
I _F (avg)	DC/Average Forward Input Current	25	mA
I _F (pk)	Peak Forward Input Current (50% duty cycle, 1ms P.W.)	50	mA
I _F (trans)	Peak Transient Input Current - ([≤1µs P.W., 300 pps)	1.0	А
V _R	Reverse Input Voltage	5	V
P _D	Input Power Dissipation	45	mW
DETECTOR			
I _O (avg)	Average Output Current (Pin 6)	8	mA
I _O (pk)	Peak Output Current	16	mA
V _{EBR}	Emitter-Base Reverse Voltage (HCPL0500/HCPL0501 only)	5	V
V _{CC}	Supply Voltage	-0.5 to 30	V
V _O	Output Voltage	-0.5 to 20	V
I _B	Base Current (HCPL0500/HCPL0501 only)	5	mA
P _D	Output power dissipation	100	mW

Electrical Characteristics ($T_A = 0$ to 70° C unless otherwise specified)

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Typ.*	Max.	Unit
EMITTER	1	1	1	1			
V _F	Input Forward Voltage	I _F = 16mA, T _A = 25°C	All		1.45	1.7	V
		I _F = 16mA				1.8	
BV _R	Input Reverse Breakdown Voltage	I _R = 10μA	All	5.0			V
$\Delta V_F / \Delta T_A$	Temperature Coefficient of Forward Voltage	I _F = 16mA	All		-1.6		mV/°C
DETECTO	R		•	•			
I _{OH} Logic High Output Current	Logic High Output Current	$I_F = 0mA, V_O = V_{CC} = 5.5V,$ $T_A = 25$ °C	All		0.001	0.5	μA
		$I_F = 0$ mA, $V_O = V_{CC} = 15$ V, $T_A = 25$ °C	All		0.005	1	
		$I_F = 0 \text{ mA}, V_O = V_{CC} = 15V$	All			50	
I _{CCL}	Logic Low Supply Current	$I_F = 16\text{mA}, V_O = \text{Open},$ $V_{CC} = 15\text{V}$	HCPL0452/3/ 0500/1		120	200	μA
			HCPL0530/1/4			400	
I _{CCH} Logic	Logic High Supply Current	I _F = 0mA, V _O = Open, V _{CC} = 15V, T _A = 25°C	All		0.01	1	μА
		$I_F = 0$ mA, $V_O = 0$ pen, $V_{CC} = 15$ V	HCPL0452/3/ 0500/1			2	
			HCPL0530/1/4			4	

Transfer Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
COUPLED			•				
CTR Cu	CTR Current Tranfer Ratio (Note 1)	, , ,	HCPL0500/0530	7	2.7	50	%
		$V_{CC} = 4.5V, T_A = 25^{\circ}C$	HCPL0452/3	19	27	50	
			HCPL0501/0531				/
		$I_F = 16mA, V_O = 0.5V,$	HCPL0500	5	30		
		$V_{CC} = 4.5V$	$V_{CC} = 4.5V$	HCPL0452/3	15	30	
			HCPL0501/0534				
V _{OL}	V _{OL} Logic Low Output Voltage	Logic Low Output Voltage I _F = 16mA, I _O = 1.1mA,	HCPL0500		0.18	0.4	V
		$V_{CC} = 4.5V, T_A = 25^{\circ}C$	HCPL0530			0.5	
		$I_F = 16\text{mA}, I_O = 3\text{mA},$	HCPL0452/3		0.25	0.4	
		$V_{CC} = 4.5V, T_A = 25^{\circ}C$	HCPL0501/0531/4				
	$I_F = 16\text{mA}, I_O = 0.8\text{mA},$ $V_{CC} = 4.5V$ $I_F = 16\text{mA}, I_O = 2.4\text{mA},$ $V_{CC} = 4.5V$	1 '	HCPL0500 HCPL0530		0.13	0.5	R)
			HCPL0452/3		0.23	0.5	
		$V_{CC} = 4.5V$	HCPL0501/0531/4				

^{*}All typicals at $T_A = 25$ °C

Electrical Characteristics (Continued) (T_A = 0 to 70°C unless otherwise specified)

Switching Characteristics $TV_{CC} = 5V$)

Symbol	Parameter	Test Conditions	Device	Min.	Тур.*	Max.	Unit
T _{PHL}	Propagation Delay Time to	$T_A = 25$ °C, $R_L = 4.1 k\Omega$, $I_F = 16 mA$ (Note 2) (Fig. 9)	HCPL0500/0530		0.45	1.5	μs
	Logic LOW	gic LOW $R_L = 1.9k\Omega, I_F = 16mA, T_A = 25^{\circ}C$ (Note 3) (Fig. 9)	HCPL0452/3		0.45	0.8	
			HCPL0501/0531/4				
		$R_L = 4.1$ kΩ, $I_F = 16$ mA (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
		$R_L = 1.9k\Omega$, $I_F = 16mA$	HCPL0452/3			1.0	
		(Note 3) (Fig. 9)	HCPL0501/0531/4				
T _{PLH}	Propagation Delay Time to	$T_A = 25$ °C, $R_L = 4.1$ k Ω , $I_F = 16$ mA (Note 2) (Fig. 9)	HCPL0500/0530		0.5	1.5	μs
	Logic HIGH	$R_L = 1.9k\Omega$, $I_F = 16mA$, $T_A = 25^{\circ}C$	HCPL0452/3		0.3	0.8	
	(Note 3) (Fig. 9)	HCPL0501/0531/4					
		$R_L = 4.1$ kΩ, $I_F = 16$ mA (Note 2) (Fig. 9)	HCPL0500/0530			2.0	
	/	$R_L = 1.9k\Omega$, $I_F = 16mA$ (Note 3) (Fig. 9)	HCPL0452/3			1.0	
			HCPL0501/0531/4				
ICM _H I	M _H I Common Mode	T _A = 25°C (Note 4) (Fig. 10)	HCPL0500	1,000 10,000		V/µs	
	Transient Immunity at		HCPL0530				
	Logic HIGH		HCPL0452	1,000	10,000		
			HCPL0501/31				
			HCPL0534	15,000	40,000		
		$I_F = 16 \text{mA}, V_{CM} = 1500 V_{P-P}$ $R_L = 1.9 \Omega, T_A = 25 ^{\circ} \text{C}$ (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		
ICM _L I	Common Mode	$I_F = 16\text{mA}, V_{CM} = 10V_{P-P}, R_L = 4.1k\Omega,$	HCPL0500	1,000	10,000		V/µs
	Transient Immunity at	T _A = 25°C (Note 4) (Fig. 10)	HCPL0530				
	Logic LOW	I _F = 16 mA, V _{CM} = 10 V _{P-P}	HCPL0452	1,000	10,000		
		$R_L = 1.9k\Omega$ (Note 4) (Fig. 10)	HCPL0501/31				
			HCPL0534	15,000	40,000		
		$I_F = 16$ mA, $T_A = 25$ °C, $V_{CM} = 1500 V_{P-P}$, $C_L = 15$ pF) (Note 4) (Fig. 10)	HCPL0453	15,000	40,000		

Isolation Characteristics

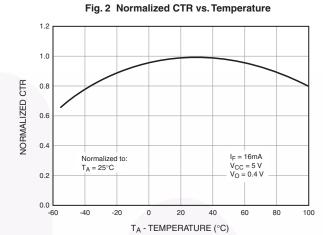
Symbol	Characteristics	Test Conditions	Min.	Тур.*	Max.	Unit
V _{ISO}	Input-Output Isolation Voltage	$f = 60 \text{ Hz}, t = 1.0 \text{ min.}, I_{I-O} \le 2\mu\text{A}$ (Note 5, 6)	2500			Vac _{RMS}
R _{ISO}	Isolation Resistance	V _{I-O} = 500V (Note 5)	10 ¹¹			
C _{ISO}	Isolation Capacitance	V _{I-O} = 0 , f = 1.0MHz (Note 5)		0.2		pF

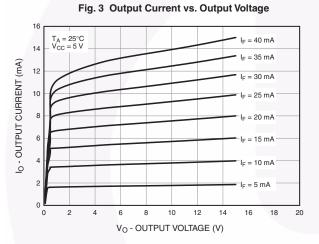
^{*}All typicals at $T_A = 25^{\circ}C$

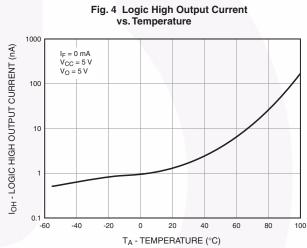
Notes

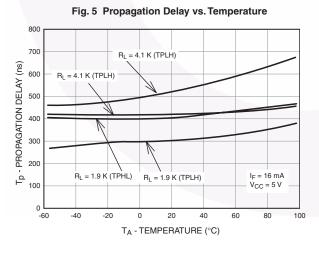
- 1 Current Transfer Ratio is designed as a ratio of output collector current, I_O, to the forward LED input current, I_F times 100%.
- 2. The 4.1 k Ω load represents 1 LSTTL unit load of 0.36 mA and 6.1k Ω pull-up resistor.
- 3. The 1.9 k Ω load represents 1 TTL unit load of 1.6 mA and 5.6 k Ω pull-up resistor.
- 4. Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse signal V_{CM} , to assure that the output will remain in a logic high state (i.e., $V_O > 2.0$ V). Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a logic low state (i.e., $V_O < 0.8$ V).
- 5. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
- 6. 2500 VAC RMS for 1 minute duration is equivalent to 3000 VAC RMS for 1 second duration.

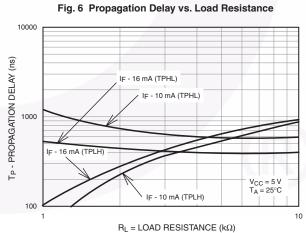
Typical Performance Curves

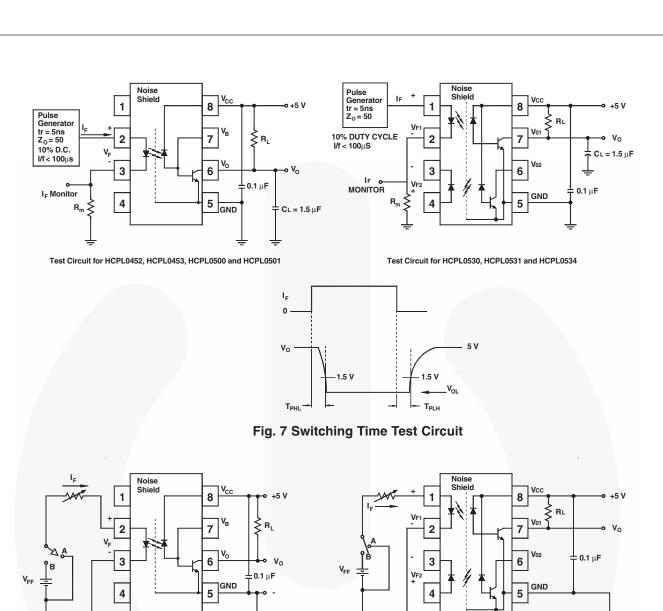


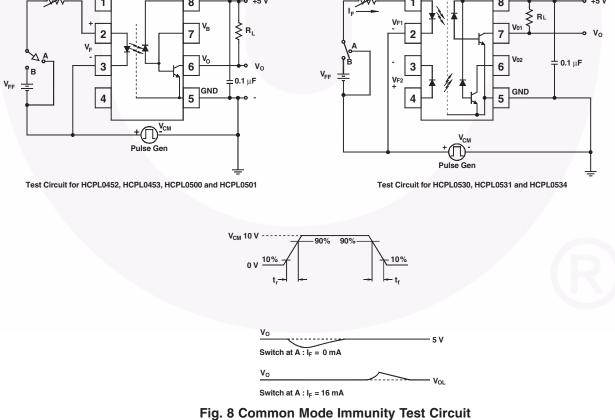








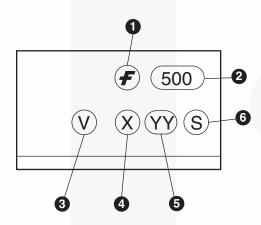




Ordering Information

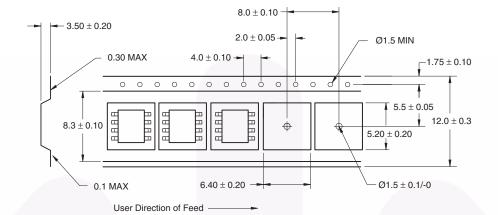
Option	Order Entry Identifier	Description
V	V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534)
R2	R2	Tape and reel (2500 units per reel)
R2V	R2V	VDE 0884 (approval pending for HCPL0530, HCPL0531 & HCPL0534), Tape and reel (2500 units per reel)

Marking Infomation

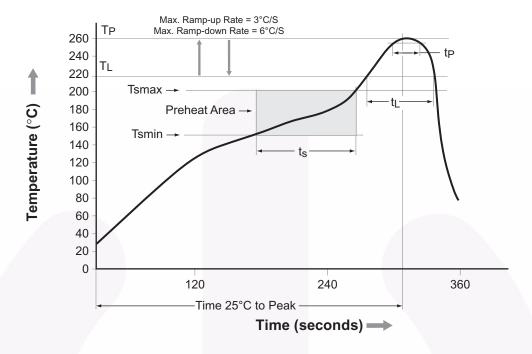


	Definitions
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One digit year code, e.g., '3'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

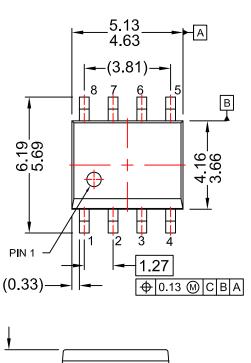
Carrier Tape Specifications

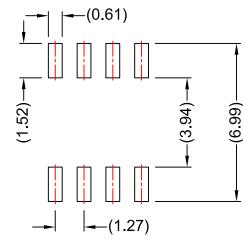


Reflow Profile

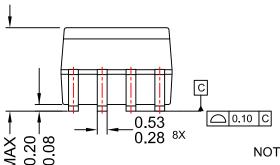


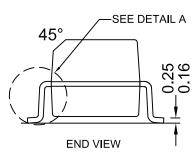
Profile Freature	Pb-Free Assembly Profile		
Temperature Min. (Tsmin)	150°C		
Temperature Max. (Tsmax)	200°C		
Time (t _S) from (Tsmin to Tsmax)	60-120 seconds		
Ramp-up Rate (t _L to t _P)	3°C/second max.		
Liquidous Temperature (T _L)	217°C		
Time (t _L) Maintained Above (T _L)	60-150 seconds		
Peak Body Package Temperature	260°C +0°C / -5°C		
Time (t _P) within 5°C of 260°C	30 seconds		
Ramp-down Rate (T _P to T _L)	6°C/second max.		
Time 25°C to Peak Temperature	8 minutes max.		





LAND PATTERN RECOMMENDATION



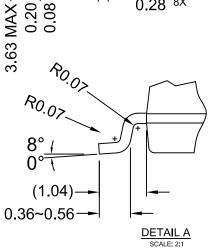






- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M.
- E) DRAWING FILENAME: MKT-M08Erev5









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PRODUCT STATUS DEFINITIONS

Definition of Terms

Definition of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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Rev 176

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